

# MECHANICAL CASE OUTLINE

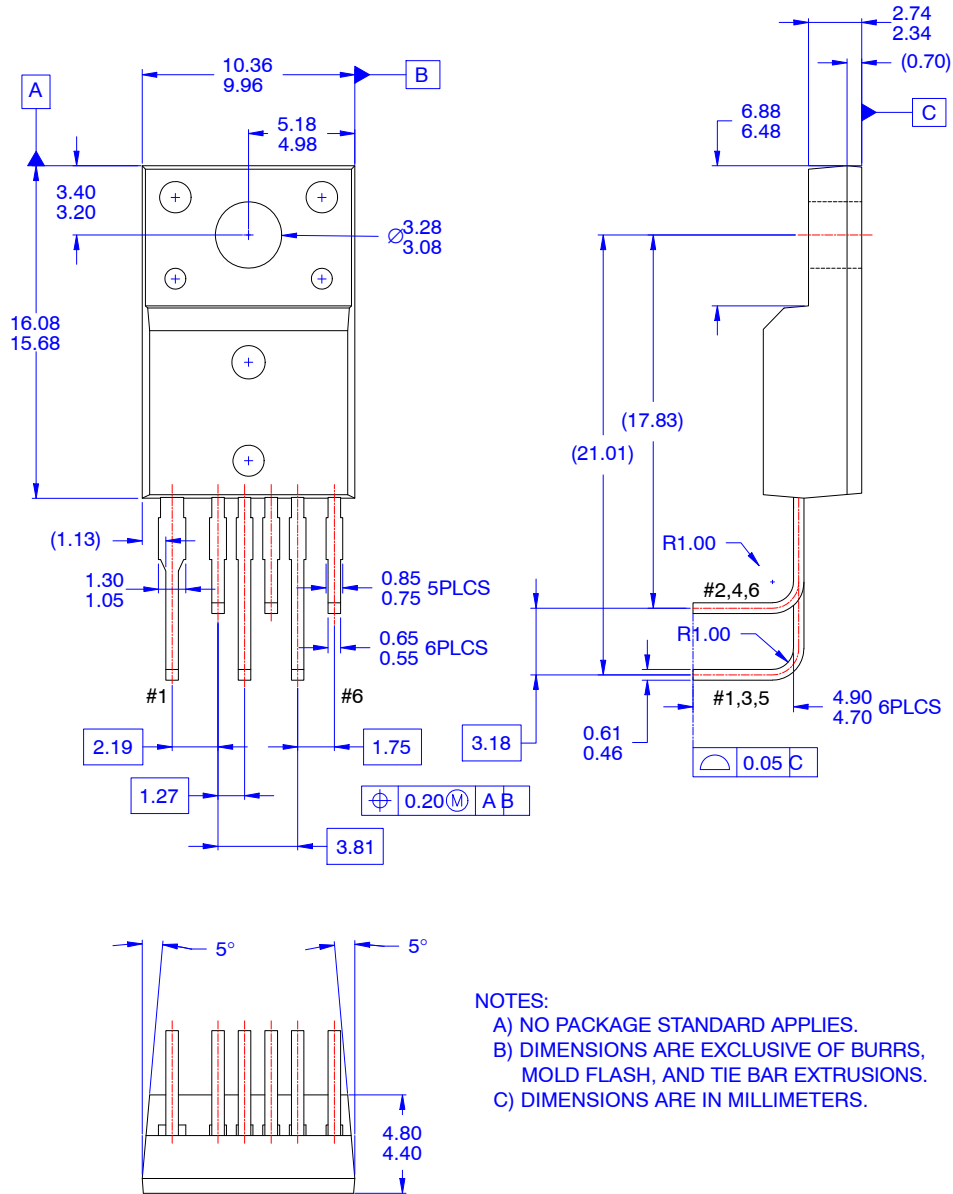
## PACKAGE DIMENSIONS

ON Semiconductor®



TO-220-6LD LF  
CASE 340BN  
ISSUE O

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- NOTES:
- A) NO PACKAGE STANDARD APPLIES.
  - B) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  - C) DIMENSIONS ARE IN MILLIMETERS.

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<b>DESCRIPTION:</b>	<b>TO-220-6LD LF</b>	<b>PAGE 1 OF 1</b>

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